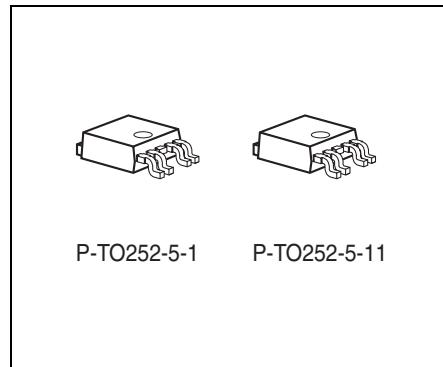


## Dual Low Drop Voltage Regulator

**TLE 4476**

### Features

- Output 1: 350 mA; 3.3 V  $\pm$  4%
- Output 2: 430 mA; 5.0 V  $\pm$  4%
- Enable input for output 2
- Low quiescent current in OFF state
- Wide operation range: up to 42 V
- Reverse battery protection: up to 42 V
- Output protected against short circuit
- Wide temperature range: -40 °C to 170 °C
- Overvoltage protection up to 65 V (< 400 ms)
- Overtemperature protection
- Overload protection

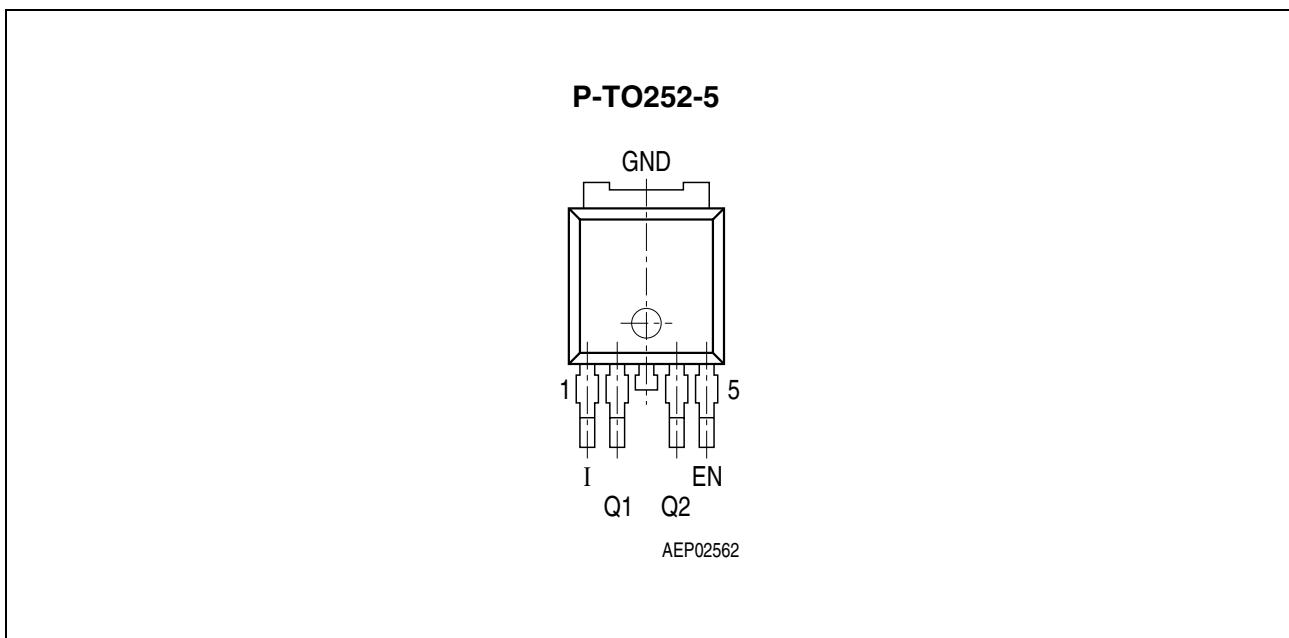


### Functional Description

The TLE 4476 is a monolithic integrated voltage regulator providing two output voltages, Q1 is a 3.3 V output for loads up to 350 mA and Q2 is a 5 V output providing 430 mA. The device is available in the P-T0252-5-1 (D-Pak) package. Output 2 can be switched ON/OFF via the Enable input EN.

The TLE 4476 is designed to supply microprocessor systems under the severe conditions of automotive applications and is therefore equipped with additional protection functions against overload, short circuit and overtemperature.

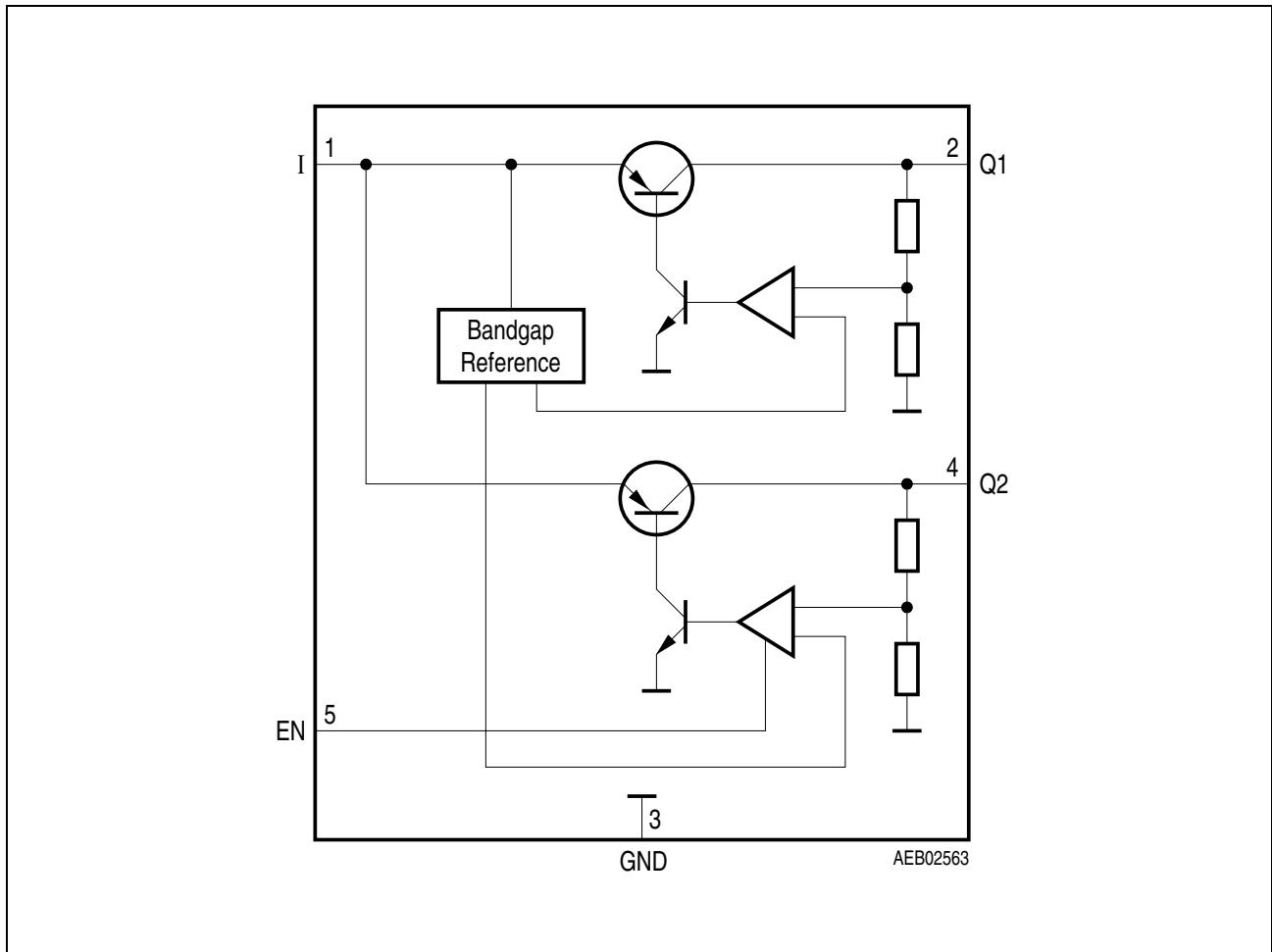
Type	Ordering Code	Package
TLE 4476 D	Q67006-A9362	P-T0252-5-1, P-T0252-5-11



**Figure 1** Pin Configuration (top view)

**Table 1** Pin Definitions and Functions

Pin No.	Symbol	Function
1	I	<b>Input voltage;</b> block to GND directly at the IC with a ceramic capacitor
2	Q1	<b>3.3 V output;</b> block to GND with a capacitor $C_{Q1} \geq 10 \mu\text{F}$ , ESR < 2 $\Omega$ at 10 kHz
3	GND	<b>Ground</b>
4	Q2	<b>5.0 V output;</b> block to GND with a capacitor $C_{Q2} \geq 10 \mu\text{F}$ , ESR < 3 $\Omega$ at 10 kHz
5	EN	<b>Enable input;</b> to switch ON and OFF Q2, ON with high signal



**Figure 2 Block Diagram**

**Table 2      Absolute Maximum Ratings**
 $-40 \text{ }^{\circ}\text{C} < T_j < 170 \text{ }^{\circ}\text{C}$ 

<b>Parameter</b>	<b>Symbol</b>	<b>Limit Values</b>		<b>Unit</b>	<b>Remarks</b>
		<b>Min.</b>	<b>Max.</b>		
<b>Input I</b>					
Voltage	$V_I$	-42 —	42 65	V V	— $t < 400 \text{ ms}$
Current	$I_I$	—	—	mA	Internally limited
<b>3.3 V Output Q1</b>					
Voltage	$V_{Q1}$	-1	36	V	—
Current	$I_{Q1}$	—	—	mA	Internally limited
<b>5.5 V Output Q2</b>					
Voltage	$V_{Q2}$	-1	36	V	—
Current	$I_{Q2}$	—	—	mA	Internally limited
<b>Inhibit EN</b>					
Voltage	$V_{EN}$	-42 —	42 65	V V	— $t < 400 \text{ ms}$
Current	$I_{EN}$	—	—	mA	Internally limited
<b>Temperatures</b>					
Junction temperature	$T_j$	-50	170	°C	—
Storage temperature	$T_{stg}$	-50	150	°C	—

**Notes**

1. *ESD-Protection according to MIL Std. 883:  $\pm 2 \text{ kV}$ .*
2. *Stresses above those listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.*

**Table 3      Operating Range**

Parameter	Symbol	Limit Values		Unit	Remarks
		Min.	Max.		
Output 1 input voltage	$V_{I1}$	4.5	42	V	1)
Output 2 input voltage	$V_{I2}$	5.7	42	V	2)
3.3 V regulator output current	$I_{O1}$	0	350	mA	—
5 V regulator output current	$I_{O2}$	0	430	mA	—
Junction temperature	$T_j$	-40	170	°C	3)

**Thermal Resistances**

Junction case	$R_{th,j-case}$	—	3	K/W	—
Junction ambient	$R_{th,j-a}$	—	80	K/W	4)

- 1) Input voltage  $V_I$  required for operation of output Q1
- 2) Input voltage  $V_I$  required for operation of output Q2
- 3) The overtemperature protection is set to  $> 170$  °C. The voltage regulator may not be operated continuously at 170 °C as device reliability will be reduced to 500 h statistic lifetime.
- 4) Worst case regarding peak temperature, zero airflow; mounted on a PCB 80 × 80 × 1.5 mm<sup>3</sup>, 35 µm Cu, 5 µm Sn, heat sink area 300 mm<sup>2</sup>.

*Note: In the operating range the functions given in the circuit description are fulfilled.*

**Table 4 Electrical Characteristics**
 $V_I = 13.5 \text{ V}$ ;  $V_{EN} > V_{ENH}$ ;  $-40^\circ\text{C} < T_j < 150^\circ\text{C}$ ; unless otherwise specified.

<b>Parameter</b>	<b>Symbol</b>	<b>Limit Values</b>			<b>Unit</b>	<b>Test Condition</b>
		<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>		
<b>3.3 V Output Q1</b>						
Output voltage	$V_{Q1}$	3.17	3.3	3.43	V	$1 \text{ mA} < I_{Q1} < 250 \text{ mA}$
Output current limitation	$I_{Q1}$	350	—	900	mA	<sup>1)</sup>
Load regulation	$\Delta V_{Q1}$	—	—	30	mV	$1 \text{ mA} < I_{Q1} < 250 \text{ mA}$
Line regulation	$\Delta V_{Q1}$	—	—	20	mV	$I_{Q1} = 5 \text{ mA};$ $6 \text{ V} < V_I < 28 \text{ V}$
Power Supply Ripple Rejection	$PSRR$	—	60	—	dB	$20 \text{ Hz} < f_r < 20 \text{ kHz}^2);$ $V_r = 5 \text{ Vpp}$
Output capacitor	$C_{Q1}$	10	—	—	$\mu\text{F}$	—
ESR of output capacitor	$R_{ESRQ1}$	—	—	2	$\Omega$	at 10 kHz
<b>5.0 V Output Q2</b>						
Output voltage	$V_{Q2}$	4.8	5.0	5.2	V	$1 \text{ mA} < I_{Q2} < 330 \text{ mA}$
Output current limitation	$I_{Q2}$	430	—	900	mA	<sup>1)</sup>
Drop voltage; $V_{DRQ2} = V_I - V_{Q2}$	$V_{DRQ2}$	—	0.3	0.7	V	$I_{Q2} = 330 \text{ mA}^1)$
Load regulation	$\Delta V_{Q2}$	—	—	50	mV	$5 \text{ mA} < I_{Q2} < 330 \text{ mA}$
Line regulation	$\Delta V_{Q2}$	—	—	50	mV	$I_{Q2} = 5 \text{ mA};$ $6 \text{ V} < V_I < 28 \text{ V}$
Power Supply Ripple Rejection	$PSRR$	—	60	—	dB	$20 \text{ Hz} < f_r < 20 \text{ kHz}^2);$ $V_r = 5 \text{ Vpp}$
Output capacitor	$C_{Q2}$	10	—	—	$\mu\text{F}$	—
ESR of output capacitor	$R_{ESRQ2}$	—	—	3	$\Omega$	at 10 kHz

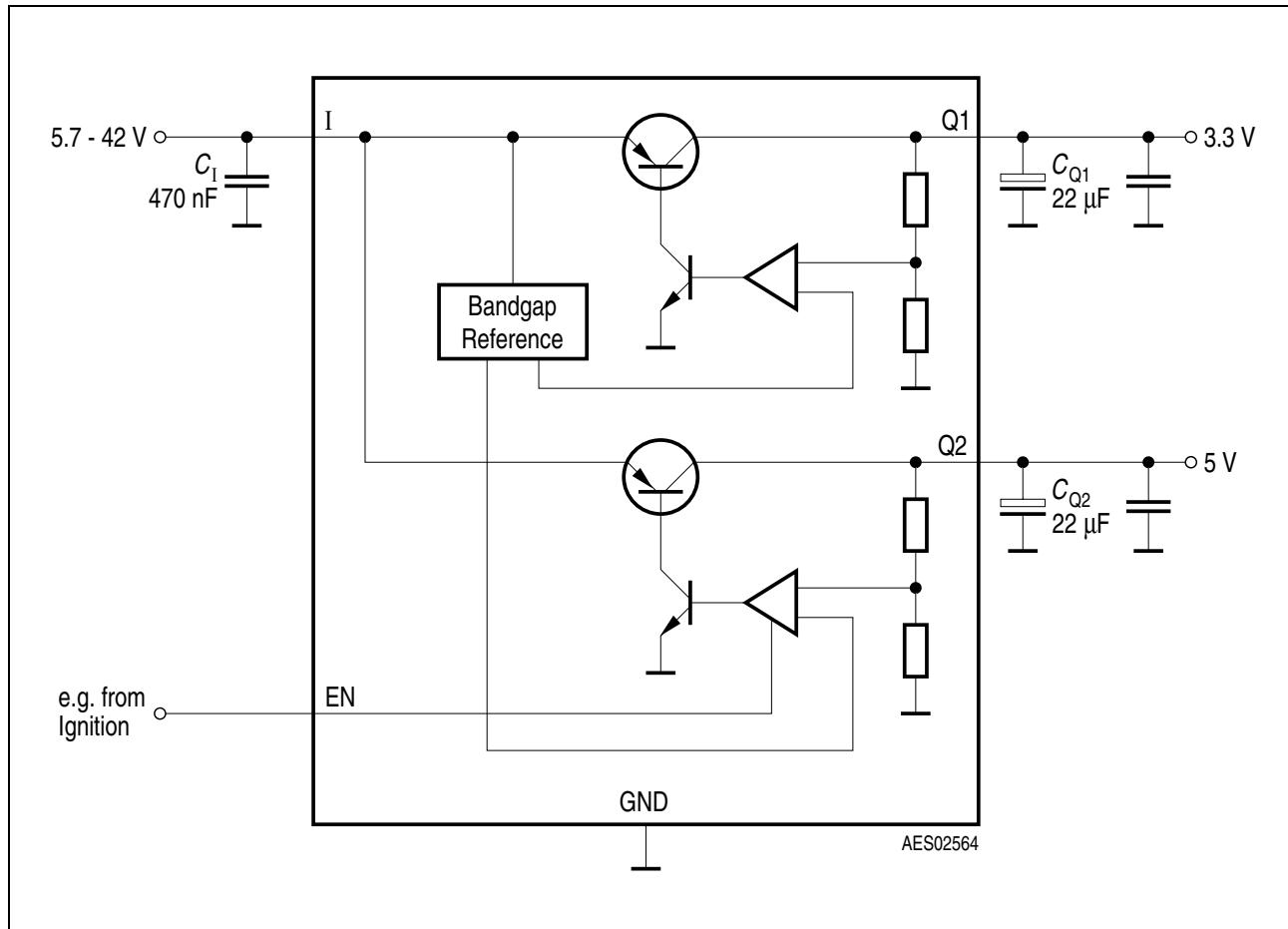
**Table 4 Electrical Characteristics (cont'd)**
 $V_I = 13.5 \text{ V}$ ;  $V_{EN} > V_{ENH}$ ;  $-40^\circ\text{C} < T_j < 150^\circ\text{C}$ ; unless otherwise specified.

<b>Parameter</b>	<b>Symbol</b>	<b>Limit Values</b>			<b>Unit</b>	<b>Test Condition</b>
		<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>		
<b>Current Consumption</b>						
Quiescent current; $I_q = I_I - I_{Q1}$	$I_q$	—	100	150	μA	$T_j < 85^\circ\text{C}$ ; $V_{EN} = 0 \text{ V}$
Quiescent current; $I_q = I_I - I_{Q1} - I_{Q2}$	$I_q$	—	300	400	μA	$I_{Q1} = I_{Q2} = 300 \mu\text{A}$ ; $T_j < 85^\circ\text{C}$
Quiescent current; $I_q = I_I - I_{Q1} - I_{Q2}$	$I_q$	—	2.5	10	mA	$I_{Q1} = 150 \text{ mA}$ ; $I_{Q2} = 300 \mu\text{A}$
Quiescent current; $I_q = I_I - I_{Q2} - I_{Q1}$	$I_q$	—	5	13	mA	$I_{Q1} = 300 \mu\text{A}$ ; $I_{Q2} = 250 \text{ mA}$
<b>Enable Input EN</b>						
EN ON voltage	$V_{EN\ ON}$	1.8	—	—	V	$V_{Q2}$ ON
EN OFF voltage	$V_{EN\ OFF}$	—	—	1.0	V	$V_{Q2}$ OFF
Input current	$V_{EN}$	—	20	30	μA	$V_{EN} = 13 \text{ V}$

 1) Measured when the output voltage  $V_Q$  has dropped 100 mV from the nominal value.

2) Guaranteed by design.

## Application Information



**Figure 3 Application Circuit**

### Input, Output

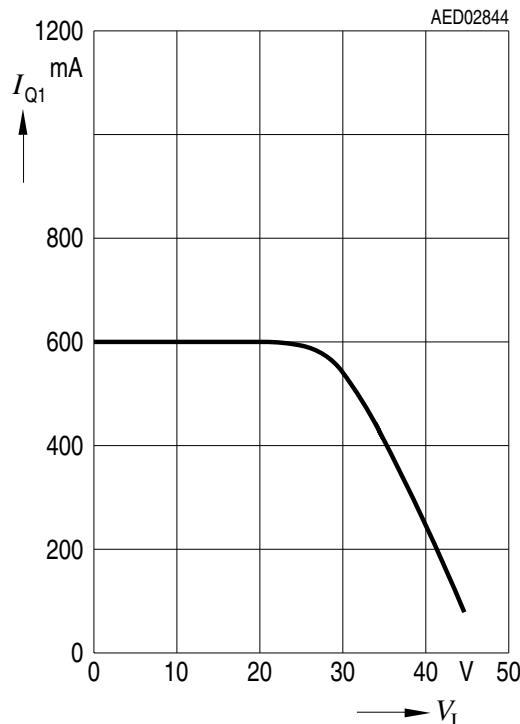
The input capacitor  $C_I$  is necessary for compensating line influences. Using a resistor of approx. 1  $\Omega$  in series with  $C_I$ , the LC circuit of input inductivity and input capacitance can be damped. To stabilize the regulation circuits of the stand-by and main regulator, output capacitors  $C_{Q1}$  and  $C_{Q2}$  are necessary. Stability is guaranteed at values  $C_{Q1} \geq 10 \mu\text{F}$  (ESR  $\leq 2 \Omega$ ) and  $C_{Q2} \geq 10 \mu\text{F}$  (ESR  $\leq 3 \Omega$ ) within the operating temperature range.

### Enable

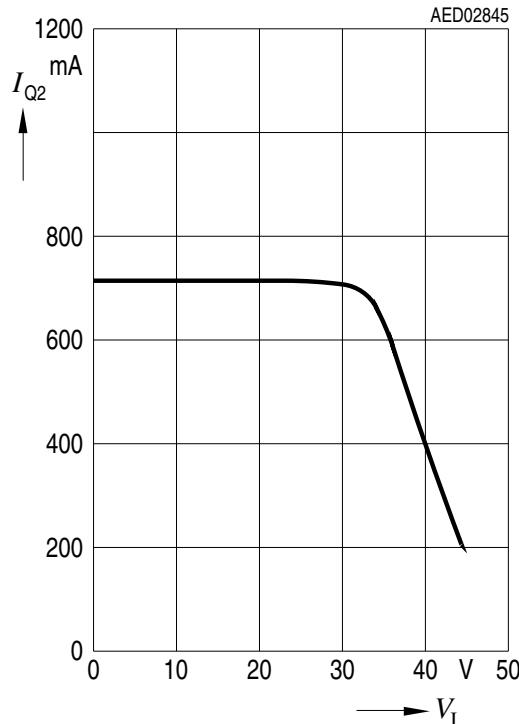
Using the enable feature the output 2 (5 V output) can be switched ON or OFF. The enable input can be connected directly to terminal 30 (battery line) or 15 (ignition line). It is also possible to control the output 2 via the microcontroller.

## Typical Performance Characteristics

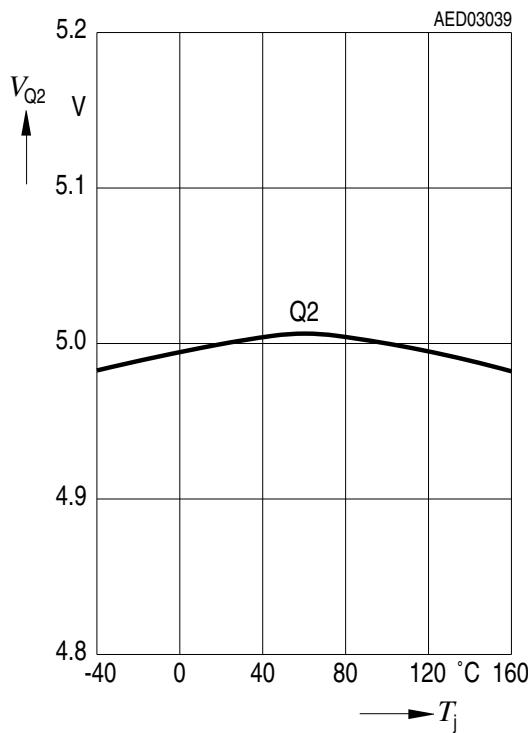
**Output Current  $I_{Q1}$  versus  
Input Voltage  $V_I$**



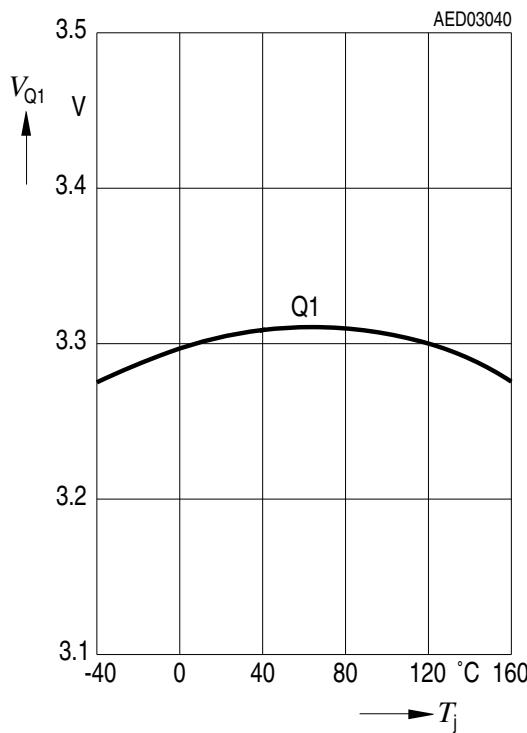
**Output Current  $I_{Q2}$  versus  
Input Voltage  $V_I$  Enable ON**



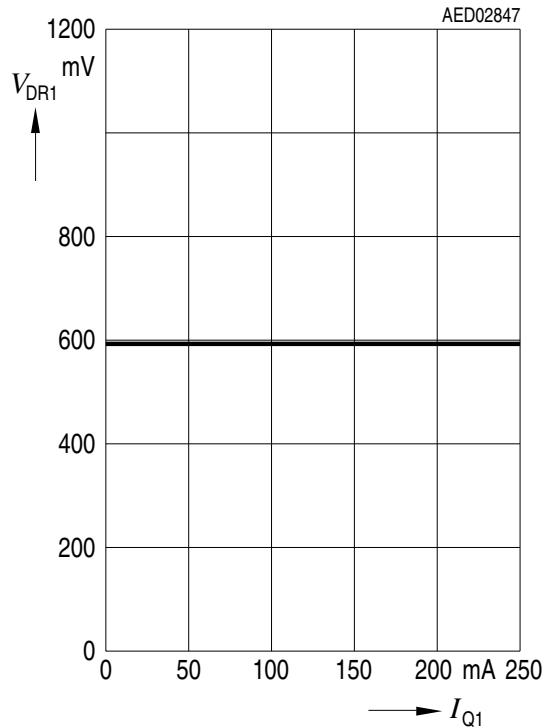
**Output Voltage  $V_{Q2}$   
versus Temperature  $T_j$**



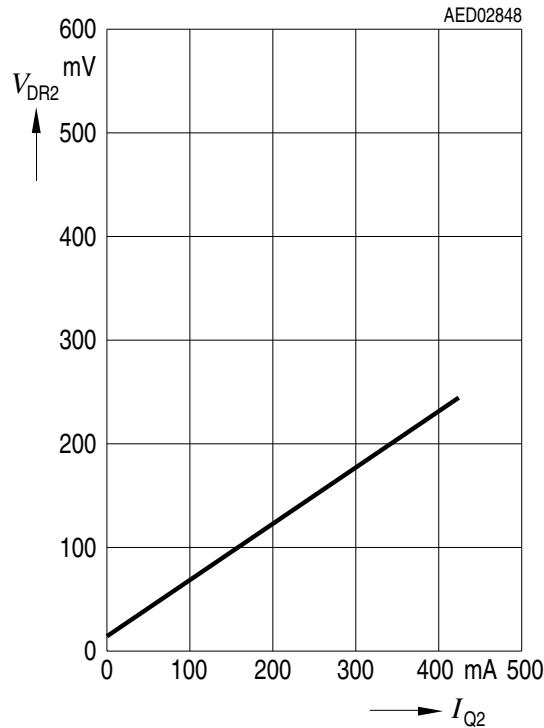
**Output Voltage  $V_{Q1}$   
versus Temperature  $T_j$**



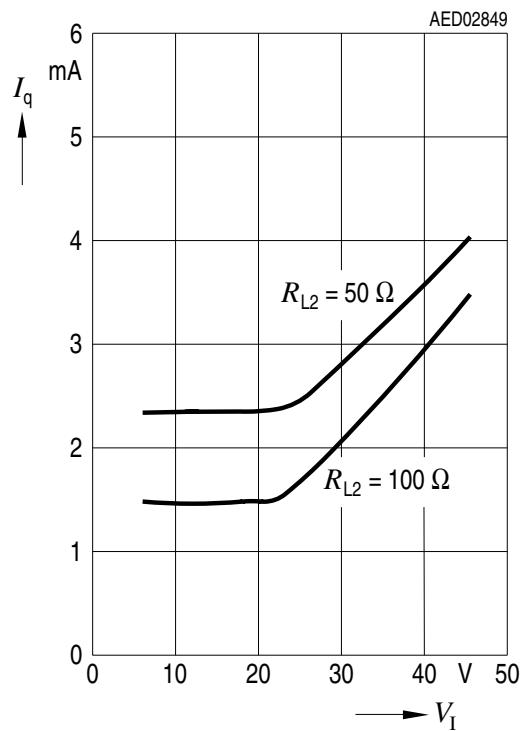
**Drop Voltage  $V_{DR1}$  versus  
Output Current  $I_{Q1}$**



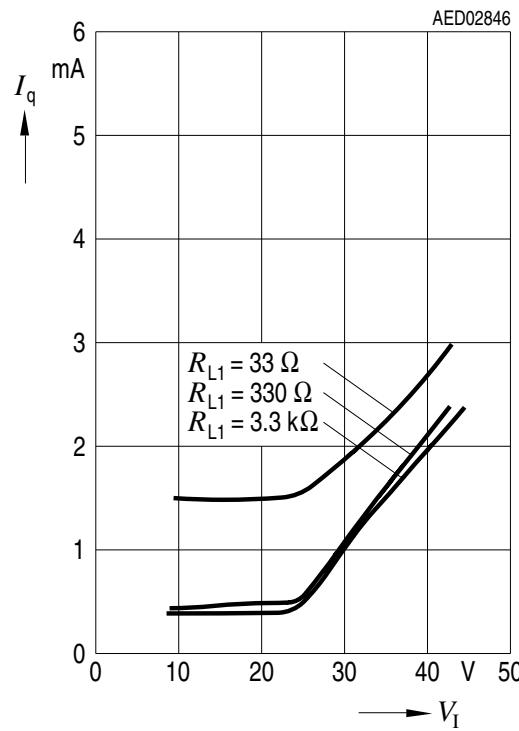
**Drop Voltage  $V_{DR2}$  versus  
Output Current  $I_{Q2}$  EN ON**



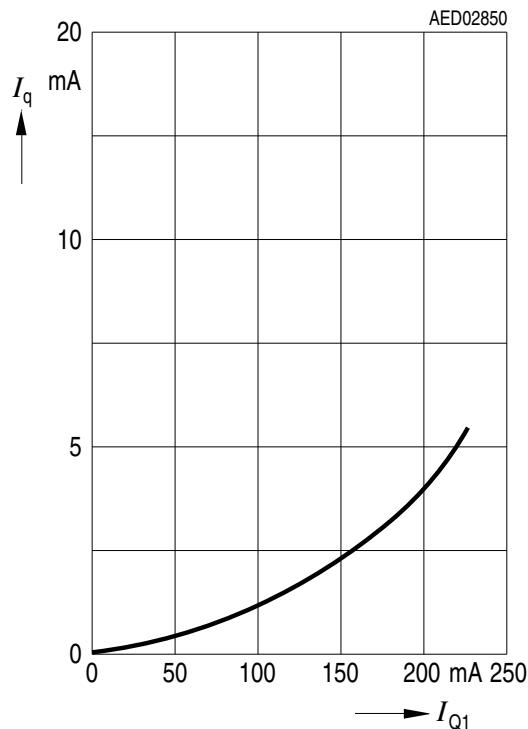
**Current Consumption  $I_q$   
versus Input Voltage  $V_I$**



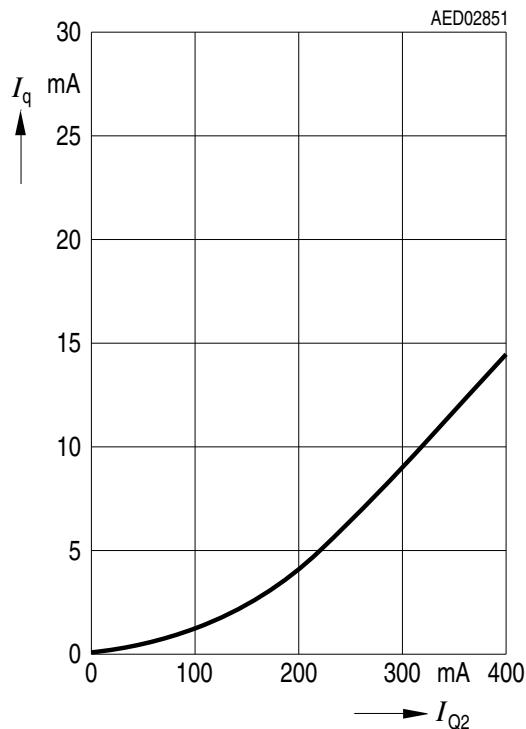
**Current Consumption  $I_q$   
versus Input Voltage  $V_I$**



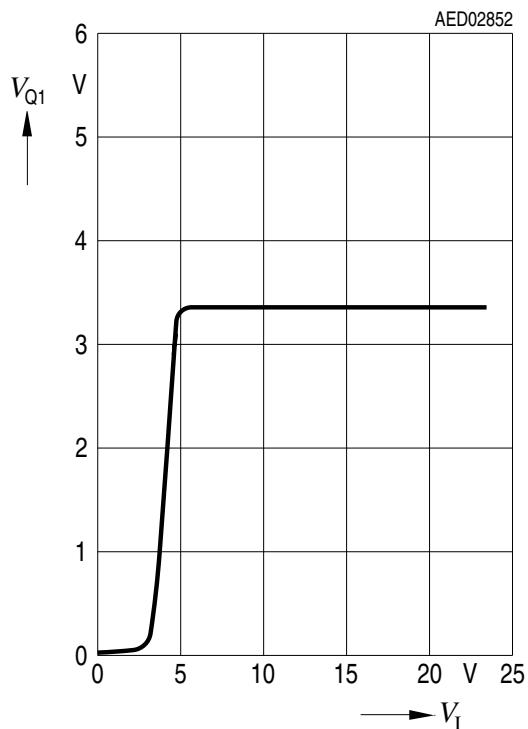
**Current Consumption  $I_q$  versus Output Current  $I_{Q1}$**



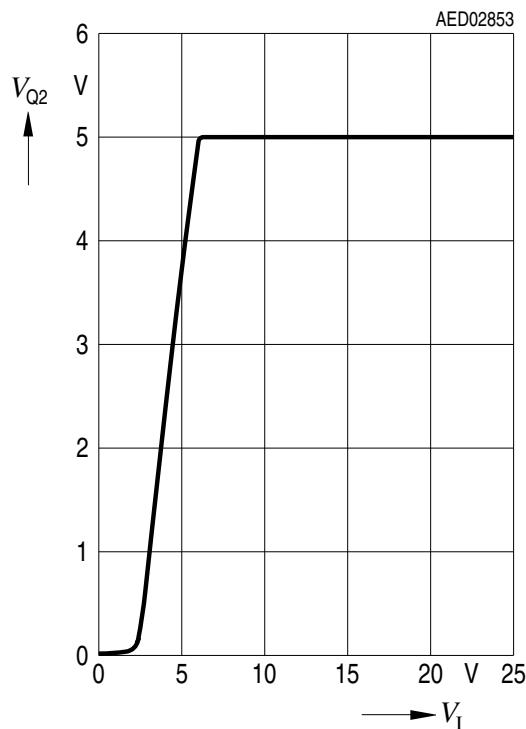
**Current Consumption  $I_q$  versus Output Current  $I_{Q2}$**



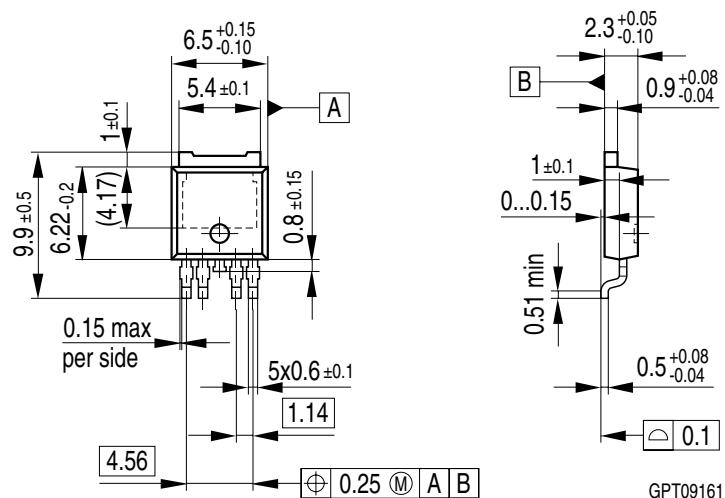
**Output Voltage  $V_{Q1}$  versus Input Voltage  $V_I$**



**Output Voltage  $V_{Q2}$  versus Input Voltage  $V_I$**



## Package Outlines



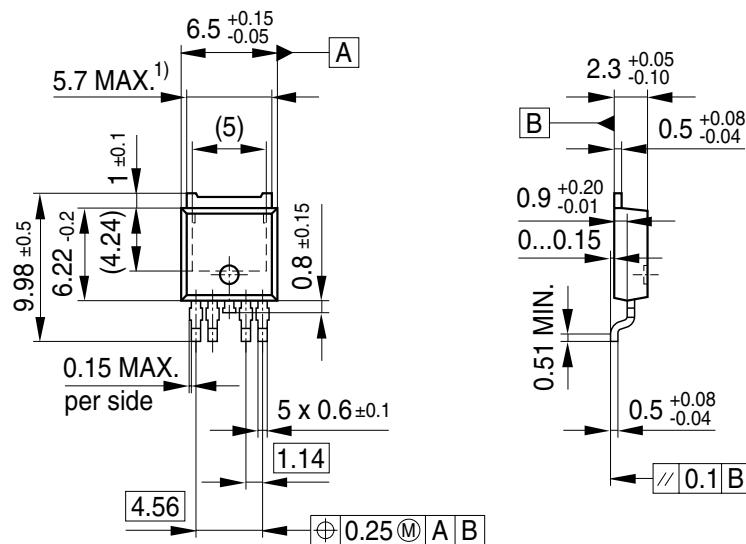
All metal surfaces tin plated, except area of cut.

**Figure 4**      **P-TO252-5-1 (Plastic Transistor Single Outline)**

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SMD = Surface Mounted Device

Dimensions in mm



- 1) Includes mold flashes on each side.  
 All metal surfaces tin plated, except area of cut.

GPT09527

**Figure 5 P-TO252-5-11 (Plastic Transistor Single Outline)**

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SMD = Surface Mounted Device

Dimensions in mm

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